

**DECLARATION AND POWER OF ATTORNEY**

*As a below-named inventor, I hereby declare that: we, Wayne A. Hendrickson, Xuliang Jiang, Keith E. Langley, Rashid Syed and Yueh-Rong Ann Hsu.  
My residence, post office address, and citizenship are as stated below next to my name.*

*I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:*

CONJUGATED LIGANDS FOR THE STIMULATION OF BLOOD CELL PROLIFERATION BY EFFECTING DIMERIZATION OF THE RECEPTOR FOR STEM CELL FACTOR

*the specification of which:*  
(check one)

X is attached hereto.

X was filed on June 29, 2000 as

Application Serial No. 09/609,027

and was amended \_\_\_\_\_  
(if applicable)

*I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.*

I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

*I hereby claim foreign priority benefits under Title 35, United States Code, Section 119 (a)-(d) or Section 365(b) of any foreign application(s) for patent or inventor's certificate, or Section 365(a) of any PCT International Application which designated at least one country other than the United States, listed below. I have also identified below any foreign application for patent or inventor's certificate, or PCT International Application having a filing date before that of the earliest application from which priority is claimed:*

*Prior Foreign Application(s)*

*Priority Claimed*

[illegible]

**Declaration and Power of Attorney**

*I hereby claim the benefit under Title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below:*

<u>Provisional Application No.</u>	<u>Filing Date</u>	<u>Status</u>
N/A		

*I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States Application(s), or Section 365(c) of any PCT International Application(s) designating the United States listed below. Insofar as this application discloses and claims subject matter in addition to that disclosed in any such prior Application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56, which became available between the filing date(s) of such prior Application(s) and the national or PCT international filing date of this application:*

<u>Application Serial No.</u>	<u>Filing Date</u>	<u>Status</u>
N/A		

**And I hereby appoint**

John P. White (Reg. No. 28,678); Christopher C. Dunham (Reg. No. 22,031); Norman H. Zivin (Reg. No. 25,385); Jay H. Maioli (Reg. No. 27,213); William E. Pelton (Reg. No. 25,702); Robert D. Katz (Reg. No. 30,141); Peter J. Phillips (Reg. No. 29,691); Wendy E. Miller (Reg. No. 35,615); Richard S. Milner (Reg. No. 33,970); Robert T. Maldonado (Reg. 38,232); Paul Teng (40,837); Richard F. Jaworski (Reg. No. 33,515); Elizabeth M. Wieckowski (Reg. No. 42,226); Pedro C. Fernandez (Reg. No. 41,741); Gary J. Gershik (Reg. No. 39,992); Jane M. Love (Reg. No. 42,812); Spencer H. Schneider (Reg. No. 45,923) and Raymond A. Diperna (Reg. No. 44,063).

*and each of them, all c/o Cooper & Dunham LLP, 1185 Avenue of the Americas, New York, New York 10036, my attorneys, each with full power of substitution and revocation, to prosecute this application, to make alterations and amendments therein, to receive the patent, to transact all business in the Patent and Trademark Office connected therewith and to file any International Applications which are based thereon under the provisions of the Patent Cooperation Treaty.*

Please address all communications, and direct all telephone calls, regarding this application to:

John P. White, Esq. Reg. No. 28,678  
Cooper & Dunham LLP  
1185 Avenue of the Americas  
New York, New York 10036  
Tel. (212) 278-0400



*I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.*

Full name of sole or  
first joint inventor

Wayne A. Hendrickson

Inventor's signature

Citizenship U.S.A.

Date of signature 22 September 2000

Residence 45 Christopher Street, Apt. 16B, New York, New York 10014

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Full name of joint  
inventor (if any)

Xuliang Jiang

Inventor's signature

~~The People's Republic~~  
Citizenship of China U.S.A.

Date of signature 29 Sept. 2000

Residence 73 Kelley Drive, Braintree, Massachusetts 02184

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Full name of joint  
inventor (if any)

Keith E. Langley

Inventor's signature

Citizenship U.S.A.

Date of signature

Residence 714 Danvers Circle, Newbury Park, CA 91320

Post Office Address same as residence

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John P. White, Esq. Reg. No. 28,678  
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Full name of sole or  
first joint inventor Wayne A. Hendrickson

Inventor's signature \_\_\_\_\_

Citizenship U.S.A. Date of signature \_\_\_\_\_

Residence 45 Christopher Street, Apt. 16B, New York, New York 10014

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Full name of joint  
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Inventor's signature \_\_\_\_\_

The People's Republic  
Citizenship of China Date of signature \_\_\_\_\_

Residence 73 Kelley Drive, Braintree, Massachusetts 02184

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Full name of joint  
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Inventor's signature Keith E. Langley

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Full name of joint  
inventor (if any) Rashid Syed

Inventor's signature [Signature]

Citizenship U.S.A. Date of signature NOV 8, 2000

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Full name of joint  
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Inventor's signature [Signature] 11/08/00

Citizenship U.S.A. Date of signature \_\_\_\_\_

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Full name of joint  
inventor (if any) \_\_\_\_\_

Inventor's signature \_\_\_\_\_

Citizenship \_\_\_\_\_ Date of signature \_\_\_\_\_

Residence \_\_\_\_\_

Post Office Address \_\_\_\_\_